

300V NPN MEDIUM POWER TRANSISTOR IN SOT223

Features

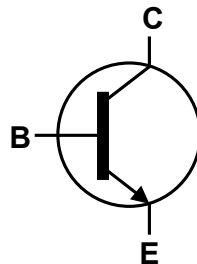
- $BV_{CEO} > 300V$
- $I_C = 3.5A$ High Continuous Collector Current
- $I_{CM} = 5A$ Peak Pulse Current
- Very Low Saturation Voltage $V_{CE(sat)} < 155mV @ 1A$
- $R_{CE(sat)} = 87m\Omega$ for a Low Equivalent On-Resistance
- h_{FE} Specified Up to 3A for a High Gain Hold Up
- Complementary PNP Type: FZT957
- **Lead-Free Finish; RoHS compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP capable (Note 4)**

Mechanical Data

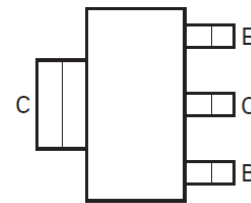
- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208③
- Weight: 0.112 grams (approximate)



Top View



Device Symbol



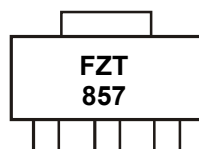
Top View
Pin-Out

Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FZT857TA	AEC-Q101	FZT857	7	12	1,000
FZT857QTA	Automotive	FZT857	7	12	1,000

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
 5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



FZT857 = Product Type Marking Code

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	350	V
Collector-Emitter Voltage	V_{CEO}	300	V
Emitter-Base Voltage	V_{EBO}	7	V
Continuous Collector Current	I_C	3.5	A
Peak Pulse Current	I_{CM}	5	A

Thermal Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

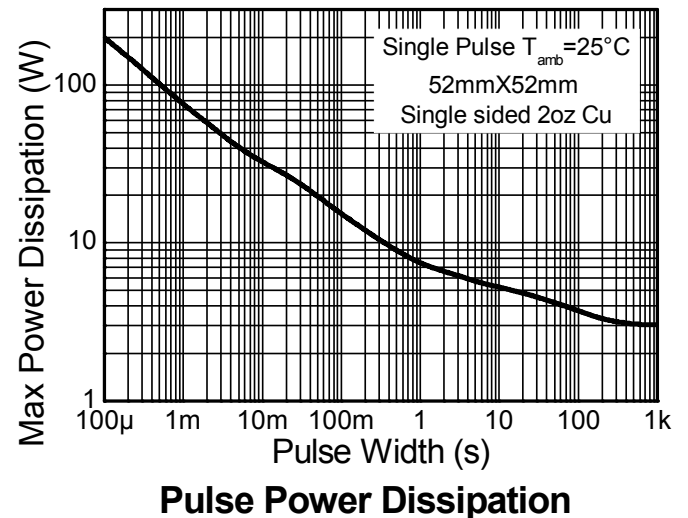
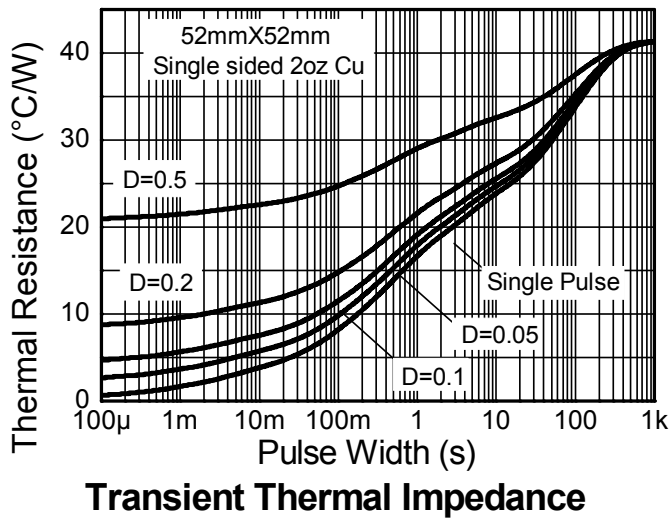
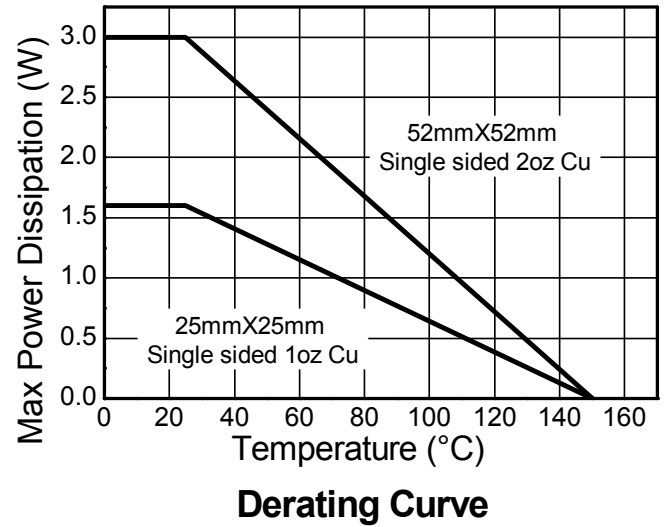
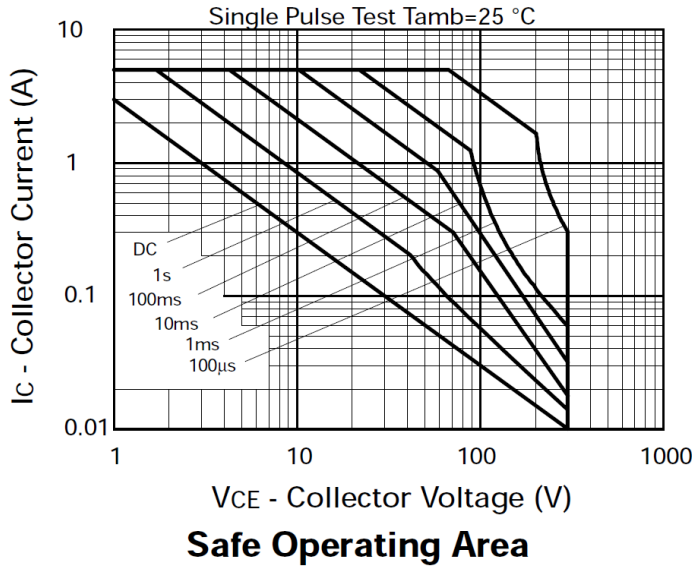
Characteristic	Symbol	Value	Unit
Power Dissipation Linear derating factor	P_D	3.0	W
		24	
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	1.6	$\text{mW}/^\circ\text{C}$
		12.8	
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	42	$^\circ\text{C}/\text{W}$
		78	
Thermal Resistance Junction to Lead	$R_{\theta JL}$	8.84	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	$\geq 8,000$	V	3B
Electrostatic Discharge - Machine Model	ESD MM	≥ 400	V	C

- Notes:
6. For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; device measured when operating in steady state condition.
 7. Same as note (6), except the device is mounted on 50mm X 50mm single sided 2oz weight copper.
 8. Thermal resistance from junction to solder-point (at the end of the collector lead).
 9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

Thermal Characteristics and Derating Information

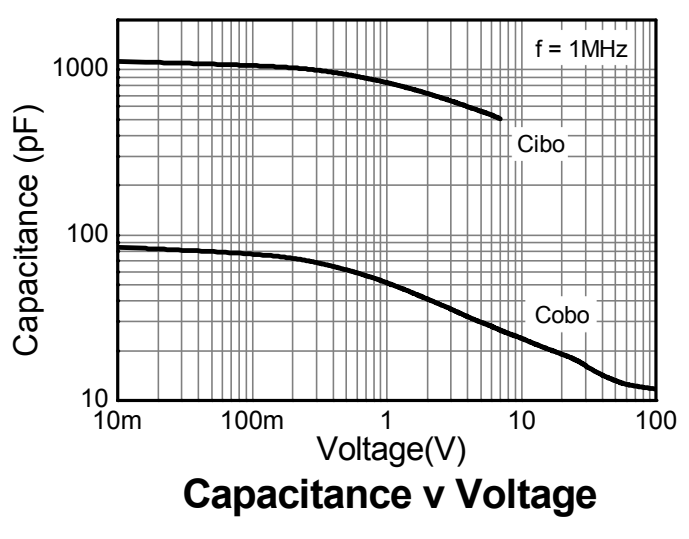
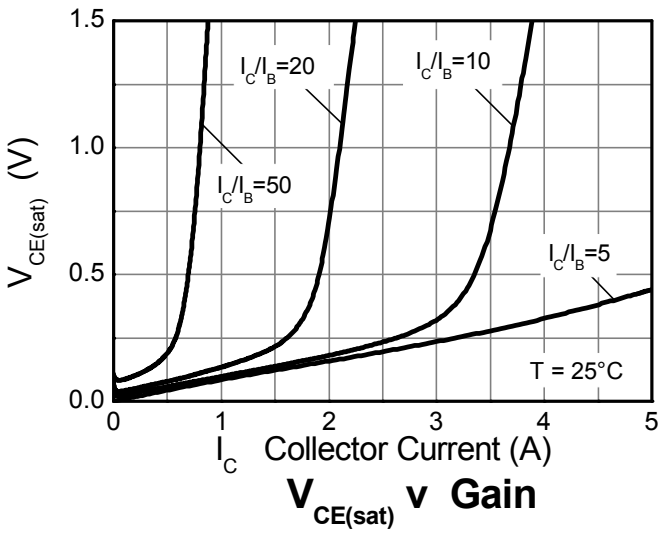
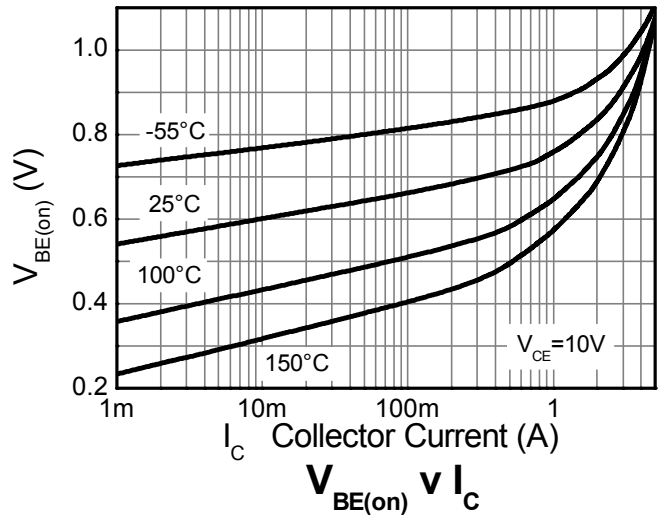
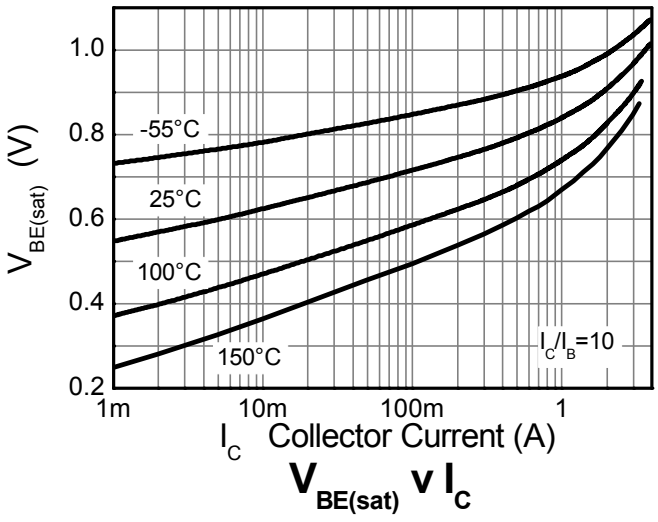
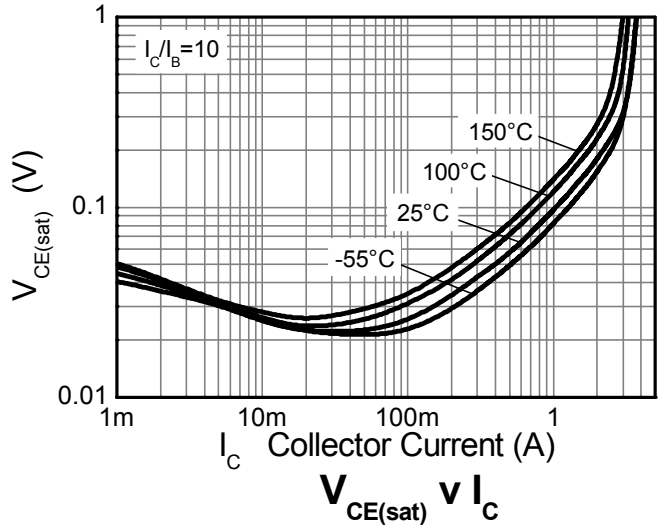
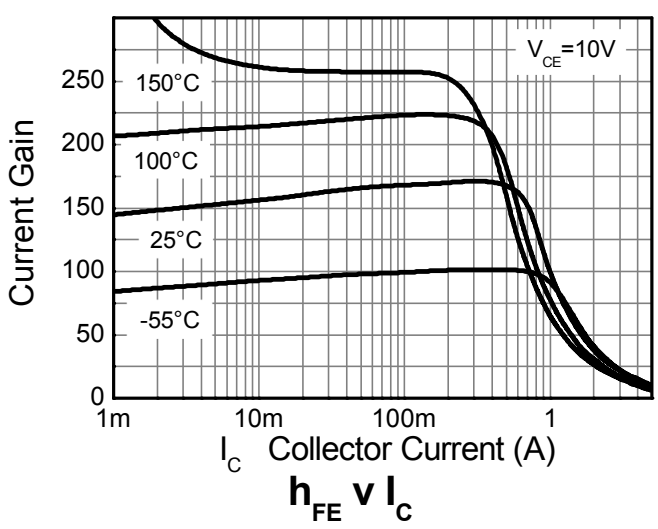


Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_{CBO}	350	475	–	V	$I_C = 100\mu\text{A}$
Collector-Emitter Breakdown Voltage	BV_{CER}	350	475	–	V	$I_C = 1\mu\text{A}$, $R_B \leq 1\text{k}\Omega$
Collector-Emitter Breakdown Voltage (Note 10)	BV_{CEO}	300	350	–	V	$I_C = 1\text{mA}$
Emitter-Base Breakdown Voltage	BV_{EBO}	7	8	–	V	$I_E = 100\mu\text{A}$
Collector Cut-off Current	I_{CBO}	–	<1	50	nA	$V_{CB} = 300\text{V}$
		–	–	1	μA	$V_{CB} = 300\text{V}$, $T_A = +100^\circ\text{C}$
Collector Cut-off Current	I_{CER}	–	<1	50	nA	$V_{CB} = 300\text{V}$, $R_B \leq 1\text{k}\Omega$
		–	–	1	μA	$V_{CB} = 300\text{V}$, $T_A = +100^\circ\text{C}$
Emitter Cut-off Current	I_{EBO}	–	<1	10	nA	$V_{EB} = 6\text{V}$
DC Current Gain (Note 10)	h_{FE}	100	200	–	–	$I_C = 10\text{mA}$, $V_{CE} = 5\text{V}$
		100	200	300		$I_C = 500\text{mA}$, $V_{CE} = 10\text{V}$
		15	25	–		$I_C = 2\text{A}$, $V_{CE} = 10\text{V}$
		–	15	–		$I_C = 3\text{A}$, $V_{CE} = 10\text{V}$
Collector-Emitter Saturation Voltage (Note 10)	$V_{CE(sat)}$	–	59	100	mV	$I_C = 500\text{mA}$, $I_B = 50\text{mA}$
		–	95	155		$I_C = 1\text{A}$, $I_B = 100\text{mA}$
		–	180	230		$I_C = 2\text{A}$, $I_B = 200\text{mA}$
		–	300	345		$I_C = 3.5\text{A}$, $I_B = 600\text{mA}$
Base-Emitter Saturation Voltage (Note 10)	$V_{BE(sat)}$	–	1020	1250	mV	$I_C = 3.5\text{A}$, $I_B = 600\text{mA}$
Base-Emitter Turn-On Voltage (Note 10)	$V_{BE(on)}$	–	940	1120	mV	$I_C = 3.5\text{A}$, $V_{CE} = 10\text{V}$
Current Gain-Bandwidth Product (Note 10)	f_T	–	80	–	MHz	$I_C = 100\text{mA}$, $V_{CE} = 10\text{V}$, $f = 50\text{MHz}$
Output Capacitance (Note 10)	C_{obo}	–	21	–	pF	$V_{CB} = 20\text{V}$, $f = 1\text{MHz}$
Switching Times	t_{on}	–	100	–	ns	$I_C = 250\text{mA}$, $V_{CC} = 50\text{V}$, $I_{B1} = -I_{B2} = 25\text{mA}$
	t_{off}	–	5300	–		

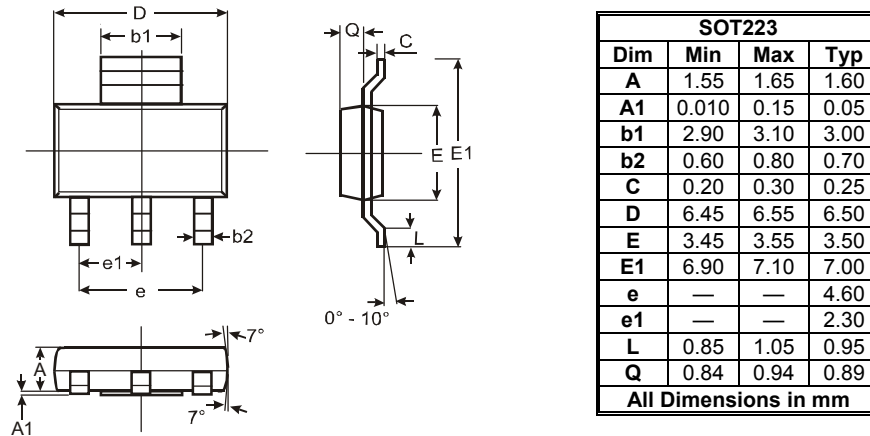
Note: 10. Measured under pulsed conditions. Pulse width $\leq 300\mu\text{s}$. Duty cycle $\leq 2\%$

Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



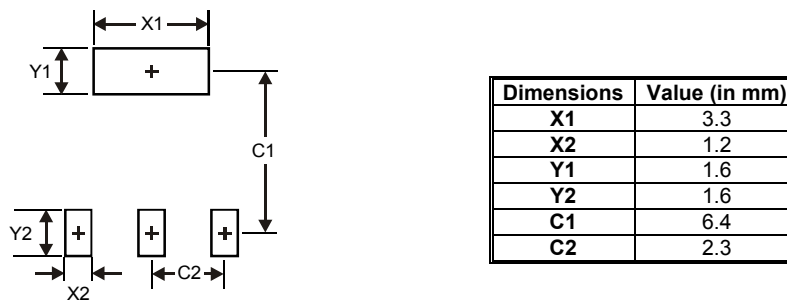
Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2013, Diodes Incorporated

www.diodes.com